L Number	Hits	Search Text	DB	Time stamp
1	111	fazan.in. and pierre.in. and micron.asn. and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:20
2	7	("5005102" | "5046043" | "5111355" | "5185689" | "5198384" | "5248628" | "5340765").PN.	USPAT	2004/11/10 11:43
3	138	5392189.URPN.	USPAT	2004/11/10 11:44
4	28	US-5436477-$.DID. OR US-5366920-$.DID. OR US-5440174-$.DID. OR US-5088694-$.DID. OR US-4788612-$.DID. OR US-4335504-$.DID. OR US-4897153-$.DID. OR US-5736448-$.DID. OR US-5708559-$.DID. OR US-5407861-$.DID. OR US-5258096-$.DID. OR US-5407855-$.DID. OR US-5586045-$.DID. OR US-5625232-$.DID.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:24
5	18	capacitor near8 (electrode) near4 (barrier or liner or cover) near4 (TiN)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:28
6	96	capacitor near12 (electrode or plate) near8 (barrier or liner or cover) near4 (TiN or ti adj n or titanium near nitride)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:57
7	2	5926359.pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:44
8	2	6635527.pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:45
9	678	capacitor near12 (electrode or plate) near4 (TiN or ti adj n or titanium near nitride)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:58
10	239	capacitor near5 (electrode or plate) near2 (TiN or ti adj n or titanium near nitride)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 12:58
-	3	6635527.pn. 5926359.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/10 11:37
-	19	("4897153" | "5153689" | "5258093" | "5272101" | "5366920" | "5387812" | "5407855" | "5407861" | "5436477" | "5439840" | "5440157" | "5440174" | "5566045" | "5625232" | "5670808" | "5708559" | "5736448" | "5866926" | "5998251").PN.	USPAT	2004/11/01 11:10
-	329	(interconnect or wiring or interconnection or metallization or trace) near8 (via or viahole) near3 (electrode or terminal or plate) near5 (capacitor or capacitive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 13:21
-	6478	(via or viahole or trench or trenched or groove) near2 (electrode or terminal or plate) near5 (capacitor or capacitive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 13:22
-	2593	(via or viahole or trench or trenched or groove) near2 (electrode) near5 (capacitor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 13:23

-	225	(via or viahole or trench or trenched or groove) near2 (lower or bottom) near (electrode) near5 (capacitor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 13:30
-	89	(ild or interlayer near dielectric or inter-layer near dielectric or passivation or passivating or dielectric near2 (spacer or spacing or separation or separating or interconnection or interconnecting or connection or connecting)) near4 (opening or hole or aperture or via or viahole) near3 (electrode or plate or terminal) near8 capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 13:58
-	859	(ild or dielectric or passivation or passivating) near4 (opening or hole or aperture or via or viahole or trench or groove) near3 (electrode or plate or terminal) near8 capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/01 14:00
-	412	(ild or dielectric or passivation or passivating) near2 (opening or hole or aperture or via or viahole or trench or groove) near3 (electrode or plate or terminal) near8 capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 10:56
-	2	("6329234" | "6472124").PN.	USPAT	2004/11/01 14:19
-	5	("5371700" | "5576240" | "5897371" | "5914851" | "6083824").PN.	USPAT	2004/11/01 14:19
-	1816	257/306.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 10:56
-	915	257/306.ccls. and (wiring or interconnection or damascene or trace or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:18
-	8	("5312777" | "5530262" | "5612254" | "5708559" | "5712813" | "5808855" | "5895948" | "5982018").PN.	USPAT	2004/11/02 12:19
-	979	438/253.ccls. and (wiring or interconnection or damascene or trace or interconnect)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:18
-	853	(438/253.ccls. and (wiring or interconnection or damascene or trace or interconnect)) not (257/306.ccls. and (wiring or interconnection or damascene or trace or interconnect))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/02 15:19
-	18	(US-5708559-$ or US-5407855-$ or US-5536672-$ or US-5563762-$ or US-6489197-$ or US-6724513-$ or US-6670237-$ or US-6583458-$ or US-6300647-$ or US-6472124-$ or US-6049103-$ or US-5608248-$ or US-5543644-$ or US-5392189-$ or US-5748521-$ or US-6008083-$ or US-5920775-$).did. or (US-20040135189-$).did.	USPAT; US-PGPUB	2004/11/09 17:40
-	2	("4149301" | "5055906").PN.	USPAT	2004/11/09 17:18
-	26	("3988824" | "4153988" | "4450048" | "4453199" | "4466177" | "4481283" | "4571816" | "4628405" | "4636833" | "4638400" | "4861141" | "4864464" | "4914497" | "4948747" | "4959705" | "4982309" | "4989053" | "4997794" | "4999689" | "5036020" | "5037772" | "5162258" | "5208726" | "5268315" | "5307310" | "5471418").PN.	USPAT	2004/11/09 17:23
-	162	capacitor same (bottom or lower) near2 (electrode or plate) near6 (fill or filling or filled) near3 (via or hole or opening or aperture or viahole or trench or groove)	USPAT; US-PGPUB	2004/11/09 17:42